SN5402, SN54LS02, SN54S02, SN7402, SN74LS02, SN74S02 QUADRUPLE 2-INPUT POSITIVE-NOR GATES

DECEMBER 1983-REVISED MARCH 1988

SDLS027

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

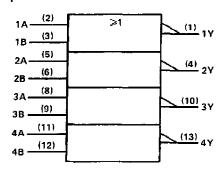
These devices contain four independent 2-input-NOR gates.

The SN5402, SN54LS02, and SN54S02 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 $\,^{\circ}\text{C}$. The SN7402, SN74LS02, and SN74S02 are characterized for operation from 0 $\,^{\circ}\text{C}$ to 70 $\,^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

| INP | UTS | OUTPUT |
|-----|-----|--------|
| Α | В | Υ |
| Н | Х | L |
| × | Н | L |
| L | L | н |

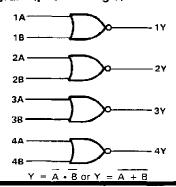
logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)



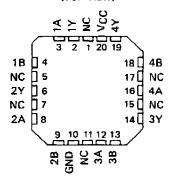
SN5402...J PACKAGE
SN54LS02, SN54S02...J OR W PACKAGE
SN7402...N PACKAGE
SN74LS02, SN74S02...D OR N PACKAGE
(TOP VIEW)

| 1Y | Цī | U 14 | □V¢¢ |
|-----|------------|------|-------|
| 1A | ₫2 | 13 | □ 4 Y |
| 18 | □3 | 12 |] 4B |
| 2Y | □4 | 11 |] 4A |
| 2A | 5 | 10 |] 3 Y |
| 2B | □ 6 | 9 | _3B |
| GND | 7 | 8 | 3A |
| | | | |

SN5402 . . . W PACKAGE (TOP VIEW)

| | _ | | | | |
|-------|----|---|----|---|-----|
| 1A [| ſī | U | 14 | Ь | 4Y |
| 18 🗆 | 2 | | 13 | ם | 4B |
| 1Y 🗀 | 3 | | 12 | | 4A |
| Vçç □ | 4 | • | 11 | ם | GND |
| 2Y 🗀 | 5 | | 10 | | 3B |
| 2A [| 6 | | 9 | | 3A |
| 2B 🗀 | 7 | | 8 | | 3Y |
| | | | | | |

SN54LS02, SN54S02 . . . FK PACKAGE (TOP VIEW)

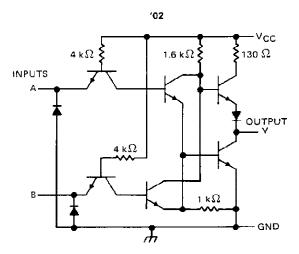


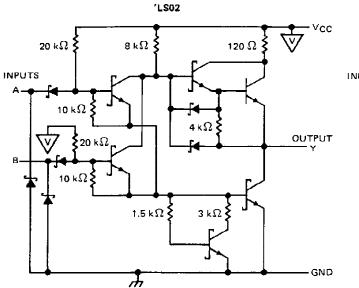
NC - No internal connection

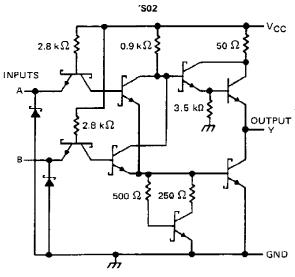
PRODUCTION DATA documents contain information current as of publication dats. Preducts conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



schematics (each gate)







Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) | |
|---------------------------------------|---------------|
| Input voltage: '02, 'S02 | |
| 'LS02 | |
| Off-state output voltage | , 7 V |
| Operating free-air temperature range: | SN54' |
| | SN74' |
| Storage temperature range | 65°C to 150°C |

NOTE 1. Voltage values are with respect to network ground terminal.



recommended operating conditions

| | : | SN5402 | _ | SN7402 | | | UNIT |
|--|-----|--------|-------|--------|-----|-------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | UNII |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | ν |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| VIL Low-level input voltage | | | 8.0 | | | 0.8 | V |
| IOH High-level output current | | | - 0.4 | | | - 0.4 | mΔ |
| IOL Low-level output current | | | 16 | | | 16 | mΑ |
| TA Operating free-air temperature | 55 | | 125 | ٥ | | 70 | °c |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| 5450445755 | TEST CONDITIONS † | | | \$N5402 | | | SN7402 | | UNIT | |
|------------------|--|------------------------------|----------|---------|------|--------------|--------|------|----------------------|-------|
| PARAMETER | (E | TEST CONDITIONS I | | MIN | TYP# | MAX | MIN | TYP‡ | MAX |] """ |
| Vικ | VCC = MIN, II = | — 12 mA | | | | - 1.5 | | | – 1. 5 | ٧ |
| Voн | VCC = MIN, VII | = 0.8 V, I _{OH} = - | - 0.4 mA | 2.4 | 3.4 | | 2.4 | 3.4 | | ٧ |
| V _{OL} | V _{CC} = MIN, V _{II} | 1 = 2 V, IOL = 10 | 6 mA | | 0.2 | 0.4 | , | 0.2 | 0.4 | ٧ |
| Ц | VCC = MAX, VI | = 5.5 V | | | | 1 | | | 1 | mA |
| Ιн | VCC = MAX, VI | = 2.4 V | - | | | 40 | | | 40 | μΑ |
| h _L | V _{CC} = MAX, V _I | = 0.4 V | | | | - 1.6 | | | - 1.6 | mΑ |
| IOS § | V _{CC} = MAX | | | - 20 | | - 55 | - 18 | | - 55 | mA |
| ¹ ССН | V _{CC} = MAX, V _I | - 0 V | | | 8 | 16 | | 8 | 16 | mA |
| CCL | V _{CC} = MAX, See | Note 2 | | ĺ | 14 | 27 | | 14 | 27 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|------------------------------------|-----|-----|-----|------|
| t _{PLH} | | | | | 12 | 22 | ns |
| ^t PHL | A or B | Υ | $R_L = 400 \Omega$, $C_L = 15 pF$ | | 8 | 15 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time.

SN54LS02, SN74LS02 QUADRUPLE 2-INPUT POSITIVE-NOR GATES

recommended operating conditions

| | - | | SN54LS02 | | | SN74LS02 | | | |
|------------------------------|-------------------|------|----------|-------------|------|----------|-------|------|--|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT | |
| V _{CC} Supply volta | ge | 4.5 | 5 | 5 .5 | 4.75 | 5 | 5.25 | v | |
| VIH High-level inp | out voltage | 2 | | | 2 | | | ٧ | |
| VIL Low-level inc | out voltage | | | 0.7 | | - | 8.0 | ٧ | |
| IOH High-level ou | tput current | | | - 0.4 | | | - 0.4 | mΑ | |
| IOL Low-level ou | tput current | | | 4 | | | 8 | mA | |
| T _A Operating fre | e-air temporature | - 55 | | 125 | 0 | | 70 | °C | |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TEST CONDITIONS † | | | SN54LS02 | | | SN74L8 | SO2 | | |
|------------------|------------------------|------------------------|---------------------------------------|----------|------|--------------|--------|-------|--------------|------|
| PARAMETER | | TEST CONDITIONS I | | MIN | TYP‡ | MAX | MIN | TYP\$ | MAX | TINU |
| VIK | VCC = MIN, | I ₁ = 18 mA | | | | — 1.5 | | | – 1.5 | V |
| ∨он | V _{CC} = MIN, | VIL = MAX, | ¹ OH = - 0.4 mA | 2.5 | 3.4 | | 2.7 | 3.4 | | ٧ |
| | V _{CC} - MIN, | V _{1H} = 2 V, | I _{OL} = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| VOL | V _{CC} = MIN, | V _{IH} = 2 V, | IOL = 8 mA | | | | | 0.35 | 0.5 | ľ |
| Ц | V _{CC} = MAX, | V _I = 7 V | . | | | 0.1 | | | 0 .1 | mΑ |
| Чн | V _{CC} = MAX, | V ₁ = 2.7 V | | | | 20 | | | 20 | μА |
| 116 | V _{CC} = MAX, | V) = 0.4 V | | | | - 0.4 | | | - 0.4 | mΑ |
| IOS§ | V _{CC} - MAX | | · · · · · · · · · · · · · · · · · · · | - 20 | | - 100 | - 20 | | - 100 | mΑ |
| ІССН | V _{CC} = MAX, | V _I = 0 V | | | 1.6 | 3.2 | | 1.6 | 3.2 | mΑ |
| ¹ CCL | VCC = MAX, | See Note 2 | | | 2.8 | 5.4 | | 2.8 | 5.4 | mА |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|---|-----|-----|-----|------|
| [₹] PLH | A or B | V | D 210 | | 10 | 15 | ns |
| tPHL | 70.0 | ı | R _L = 2 kΩ, C _L = 15 pF | | 10 | 15 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[†] All typical values are at $V_{\rm CC}$ = 5 V, $T_{\rm A}$ = 25°C § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second. NOTE 2: One input at 4.5 V, all others at GND.

recommended operating conditions

| | | | SN54S0 | 2 | SN74S02 | | | |
|-----|--------------------------------|-----|--------|------------|---------|-----|------------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | ٧ |
| ٧١L | Low-level input voltage | | | 8.0 | | | 0.8 | ٧ |
| lон | High-level output current | | | – 1 | | | – 1 | mΑ |
| loL | Low-level output current | | | 20 | | | 20 | mΑ |
| Тд | Operating free-air temperature | 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST CONDITIONS † | SN54S02 SN74S02 | |
|-------------------|--|-----------------------------|--------|
| PARAMETER | TEST CONDITIONS | MIN TYP\$ MAX MIN TYP\$ MAX | דואט - |
| VIK | V _{CC} = MIN, I _I = -18 mA | -1.2 -1.3 | 2 V |
| V _{OH} | V_{CC} = MIN, V_{IL} = 0.8 V, I_{OH} = -1 | nA 2.5 3.4 2.7 3.4 | ٧ |
| VOL | V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 20 I | A 0.5 0.6 | V |
| Ц | V _{CC} = MAX, V _I = 5.5 V | 1 | mA |
| ЧН | V _{CC} = MAX, V _I = 2.7 V | 50 50 |) μΑ |
| կը | V _{CC} = MAX, V _I = 0.5 V | -2 -2 | ! mA |
| l _{OS} § | V _{CC} = MAX | _40 _100 _40 _100 |) mA |
| ¹ ссн | V _{CC} = MAX, V _I = 0 V | 17 29 17 29 | mA |
| CCL | V _{CC} = MAX, See Note 2 | 26 45 26 45 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN TYP | MAX | UNIT |
|-----------|-----------------|----------------|---|---------|-----|------|
| tPLH | | | $R_1 = 280 \Omega$, $C_1 = 15 pF$ | 3.5 | 5,5 | ns |
| tPHL | A or B | Y | R _L = 280 Ω, C _L = 15 pF | 3.5 | 5,5 | ns |
| tPLH | | | $R_1 = 280 \Omega$, $C_L = 50 pF$ | 5 | | ns |
| tPHL | | | $R_{\perp} = 280 \Omega$, $C_{\perp} = 50 pF$ | 5 | | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{\Delta} = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| JM38510/00401BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/00401BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/00401BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/07301BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/07301BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/07301BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/07301BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301BDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301SCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301SCA | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301SDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/30301SDA | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN5402J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN5402J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54LS02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54LS02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54S02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54S02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN7402N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN7402N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN7402N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN7402N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN7402NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN7402NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74LS02D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS02D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS02DE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS02DE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS02DR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS02DR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |





om 17-Oct-2005

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Packag Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽ |
|------------------|-----------------------|-----------------|--------------------|------|---------------|---------------------------|------------------|----------------------------|
| SN74LS02DRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIN |
| SN74LS02DRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIN |
| SN74LS02J | OBSOLETE | CDIP | J | 14 | | TBD | Call TI | Call TI |
| SN74LS02J | OBSOLETE | CDIP | J | 14 | | TBD | Call TI | Call TI |
| SN74LS02N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74LS02N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74LS02N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN74LS02N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN74LS02NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74LS02NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74LS02NSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74LS02NSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74LS02NSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74LS02NSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74S02D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74S02D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74S02DE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74S02DE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLI |
| SN74S02DR | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI |
| SN74S02DR | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI |
| SN74S02N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74S02N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74S02N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN74S02N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI |
| SN74S02NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74S02NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SNJ5402J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ5402J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ5402W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ5402W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54LS02FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |



PACKAGE OPTION ADDENDUM

17-Oct-2005

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp (3) |
|------------------|-----------------------|-----------------|--------------------|------|----------------|--------------|------------------|-------------------|
| SNJ54LS02FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54LS02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54LS02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54LS02W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54LS02W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02J | ACTIVE | CDIP | J | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54S02W | ACTIVE | CFP | W | 14 | 1 | TBD | Call TI | Level-NC-NC-NC |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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